# AP3 Rec'd PCT/PTO 02 JUN 2008

# **Application Data Sheet**

#### **Application Information**

Application Type::
Subject Matter::

Regular Utility

Suggested classification::

Suggested Tech. Center:: CD-ROM or CD-R?::

Number of CD disks:: Number of Copies of CDs::

Number of Copies of CDs:: Sequence Submission::

Computer Readable Form (CRF)::

Number of copies of CRF::

Title Line One:: Bonding Method, Device Formed By Such Method, Surface Activating Unit And Bonding

Title Line Three:: Apparatus Comprising Such Unit

Docket Number:: YANE-0004-US1

Request for Early Publication::

Request for Non-publication::

Suggested Drawing Figure::

Total Drawing Sheets::

Small Entity::

No

Latin name::

Variety denomination name::

Petition included?:: No

Petition Type::

Licensed US Govt. Agency :: Contract or Grant Numbers One:: Contract or Grant Numbers Two::

Secrecy Order in Parent Appl.:: No

## **Applicant Information**

Applicant One Authority Type:: Inventor

Primary Citizenship Country:: JP

Status :: Full Capacity
Given Name:: Masuaki

Middle Name::

Family Name:: OKADA

Name Suffix::

City of Residence:: Osaka

State or Prov. of Residence::

Country of Residence:: JP

Mailing Address Line One:: 279-1-510, Fukaisawa-machi,

Mailing Address Line Two:: Sakai-shi
City of Mailing Address:: Osaka

State or Province of Mailing Address::

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Postal or Zip Code of Mailing Address:: 5998236

#### **Correspondence Information**

Correspondence Customer Number::

22,506

Name::

Jagtiani + Guttag

Street of mailing address::

10363-A Democracy Lane

City of mailing address::

Fairfax

State or Province mailing address::

VA

Country of mailing address:: Postal or Zip Code of mailing address:: 22030

US

Phone Number::

703-591-2664

Fax Number::

703-591-5907

E-Mail Address::

mail@jagtiani.com

# Representative Information

Representative Customer Number::

22,506

#### **Domestic Priority Information**

Application:: This application	Continuity Type:: National Stage of	Parent Application:: PCT/JP2004/017934	Parent Filing Date:: 12-02-2004

### **Foreign Application Information**

Country::	Application number::	Filing Date::	Priority Claimed::
JP	2003-402526	12-02-2003	Yes
JP	2004-069865	03-12-2004	Yes
JP	2004-069866	03-12-2004	Yes

#### **Assignee Information**

Assignee name:: Bondtech, Inc.

Street of mailing address one::Keihanna Plaza Labo-to, 1-7, Hikari-dai,

Street of mailing address two:: Seika-cho, Soraku-gun

City of mailing address::Kyoto

State or Province of mailing address::

Country of mailing address::JP

Postal or Zip Code of mailing address::6190237